SB07-03P

Schottky Barrier Diode 30V, 0.7A, Low IR, Single PCP



Applications

• High frequency rectification (switching regulators, converters, choppers)

Features

- Low forward voltage (VF max=0.55V)
- Fast reverse recovery time (trr max=10ns)

- Low switching noise
- · Low leakage current and high reliability due to highly reliable planar structure

Specifications

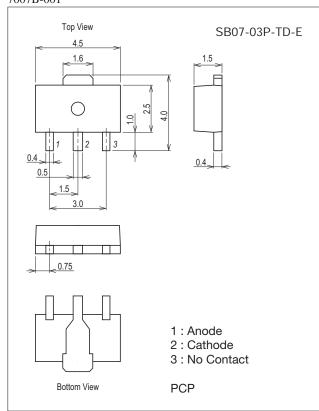
Absolute Maximum Ratings at Ta=25°C

| Parameter | Symbol | Conditions | Ratings | Unit |
|--|------------------|-------------------------|-------------|------|
| Repetitive Peak Reverse Voltage | V _{RRM} | | 30 | V |
| Nonrepetitive Peak Reverse Surge Voltage | V _{RSM} | | 35 | V |
| Average Output Current | IO | | 700 | mA |
| Surge Forward Current | IFSM | 50Hz sine wave, 1 cycle | 5 | А |
| Junction Temperature | Тј | | -55 to +125 | °C |
| Storage Temperature | Tstg | | -55 to +125 | °C |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Package Dimensions

unit : mm (typ) 7007B-001



Product & Package Information

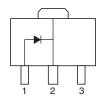
- Package : PCP
- JEITA, JEDEC : SC-62, SOT-89, TO-243
- Minimum Packing Quantity : 1,000 pcs./reel

Packing Type: TD



Marking

Electrical Connection

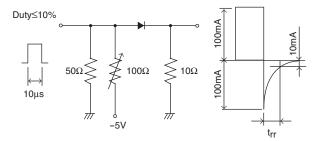


Semiconductor Components Industries, LLC, 2013 September, 2013

Electrical Characteristics at Ta=25°C

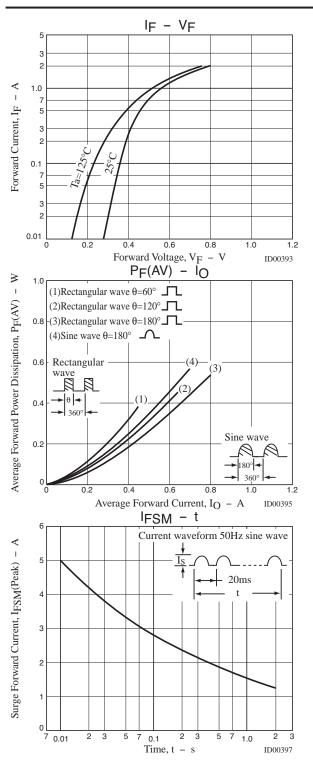
| Parameter | Symbol | Conditions | Ratings | | | Unit | |
|---------------------------|-----------|---|---------|-----|------|--------|--|
| Parameter | Symbol | Conditions | min | typ | max | Unit | |
| Reverse Voltage | VR | IR=300μA | 30 | | | V | |
| Forward Voltage | VF | IF=700mA | | | 0.55 | V | |
| Reverse Current | IR | V _R =15V | | | 80 | μΑ | |
| Interterminal Capacitance | С | V _R =10V, f=1MHz | | 26 | | рF | |
| Reverse Recovery Time | trr | IF=IR=100mA, See specified Test Circuit. | | | 10 | ns | |
| Thermal Resistance | Rth(j-a)1 | | | 310 | | °C / W | |
| | Rth(j-a)2 | When mounted on ceramic substrate (250mm ² ×0.8mm) | | 120 | | °C / W | |

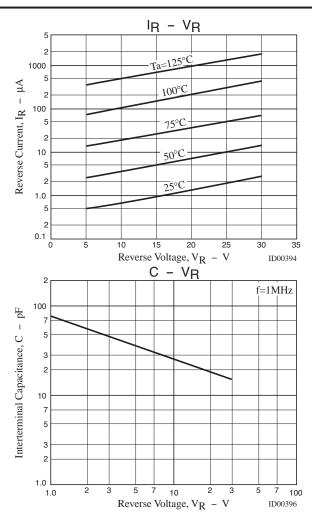
trr Test Circuit



Ordering Information

| 3 | | | | | |
|---------------|------------------|--|---------|--|--|
| Device | Device Package | | memo | | |
| SB07-03P-TD-E | 307-03P-TD-E PCP | | Pb Free | | |





Embossed Taping Specification SB07-03P-TD-E

1. Packing Format

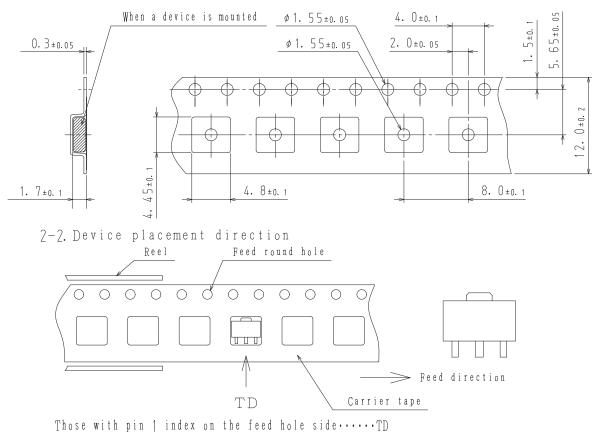
| Package Name | Carrier Tape | Maximum Number of devices contained (pcs) | | | Packing format | | | |
|---|--------------|--|-----------|-----------------|----------------------|---------------------------|-----------|---|
| | Туре | Reel | Inner box | Outer box | Inner BOX (C-1) | | (C-1) | Outer BOX (A-7) |
| РСР | PCP | 1,000 | 4,000 | 24,000 | 4 ree | els containe | d | 6 inner boxes contained |
| | | | | | Dime | []imensions:mm (external) | | Dimensions:mm (external) |
| | | | | | 18 | 3 × 7 2 × | 185 | 440×195×210 |
| | | | | | | | | |
| Packing met | h o d | | | (u 1 | nit:r | nm) | The form | label at the time of factory shipments n of a label may change in physical ation process. |
| ° | | | < | 6 | 59 | > | < | 108 |
| | Туре | | |) TYPE OOOC | 00000 | | | YPE CODE # |
| | LOT | | | T) LOT OO | | | | |
| | ///// Quan | tity | |) QTY 0, 00 | 00 (1) LE | AD FREE * \- | | NTY O, OOO PCS (1) LEAD FREE # .0T |
| | Orig | in | |) SPECIAL | | | | PACKAGE OOOOOOOO |
| | 0118 | | . [| | DIFFOSIO | <u>v:****)</u> ¥ | | ECIAL #20722005310C* SSEMBLY:***** (DIFFUSION:*****) |
| Reel label The LEAD FREE & description shows that the surface treatment of the terminal is lead free. | | | | | | at the surface | | |
| | | | tr | eatment - | ot the | terminal i | s lead fr | ee. |
| | | | | Label | | JEITA | | |
| | | | | LEAD FRE | EE 3 | JEITA P | hase 3A | |

LEAD FREE 4

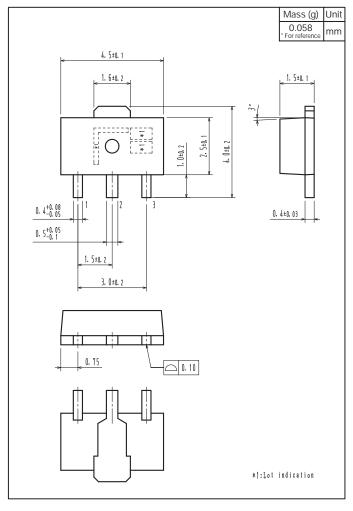
JEITA Phase 3

2. Taping configuration

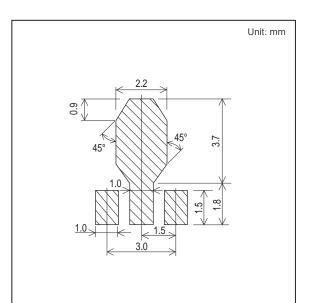
2-1. Carrier tape size (unit:mm)



Outline Drawing SB07-03P-TD-E



Land Pattern Example



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